

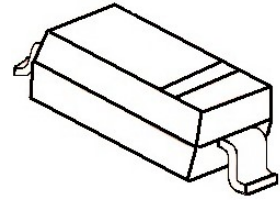
500mW SOD-123 Fast Switching Diode

Features

- 4.0nS; Fast Switching Device (TRR <4.0 nS)
- Power Dissipation of 500mW
- High Stability and High Reliability
- Low reverse leakage

Mechanical Data

- SOD-123 Small Outline Plastic Package
- Polarity: Color band denotes cathode end
- Epoxy UL: 94V-0
- Mounting Position: Any

SOD-123

MARKING:

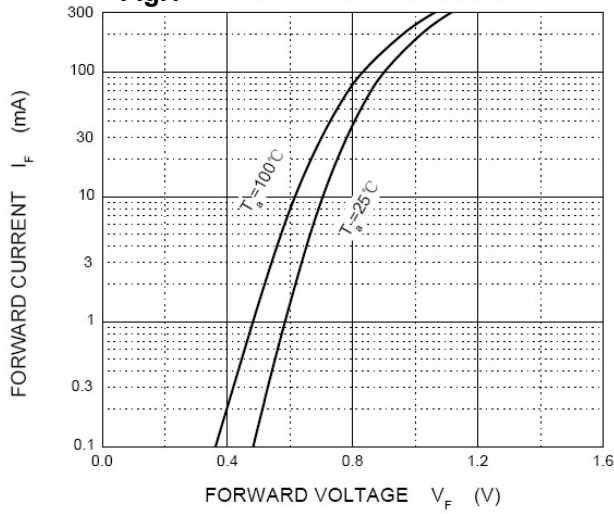
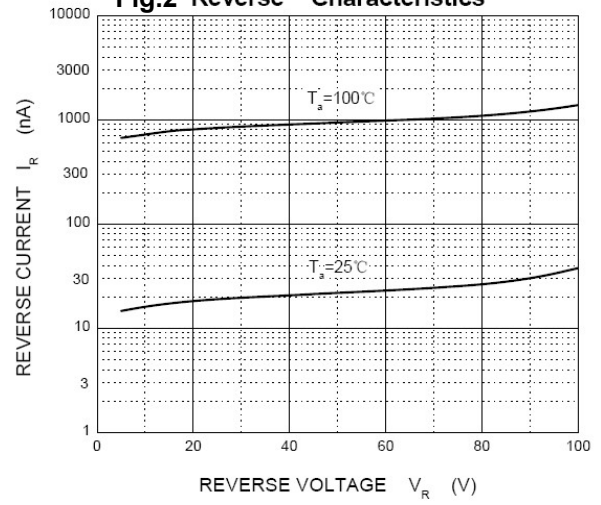
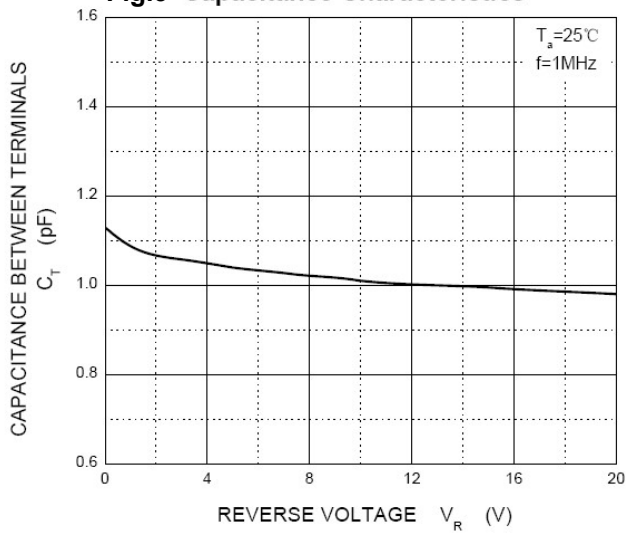
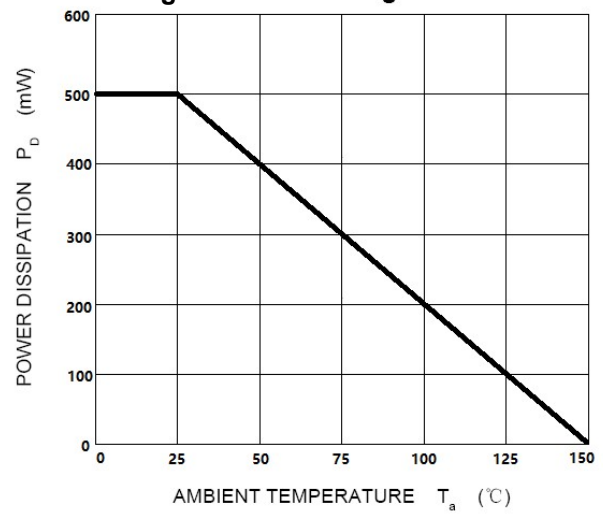

Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

Parameters	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	100	V
Power Dissipation	P_d	500	mW
Operating junction temperature	T_j	150	°C
Storage temperature range	T_{STG}	-65-+150	°C
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	250	°C/W
Average Rectified Current	I_o	150	mA
Peak Forward Current	I_{FM}	300	mA
Non-Repetitive Forward Surge Current @ $t_p=1\mu s$; $T_A=25^\circ C$	I_{FSM}	2.0	A

Valid provided that electrodes are kept at ambient temperature.

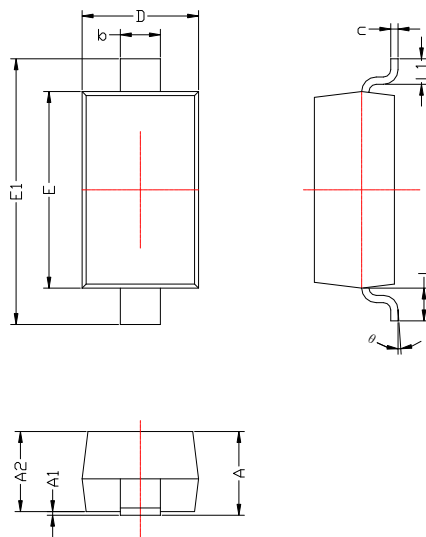
Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

Parameters	Symbol	Test Condition	Limits		Unit
			Min	Max	
Breakdown Voltage	B_V	$I_R=100\mu A$	100		V
Reverse Leakage Current	I_R	$V_R=20V$	---	25	nA
		$V_R=20V$ $T_j=150^\circ C$	---	50	μA
		$V_R=75$	---	5	μA
Forward Voltage	V_F	$I_F=10mA$	---	1.00	V
		$I_F=100mA$	---	1.25	
Reverse Recovery Time	TRR	$I_F = I_R = 10mA,$	---	4	nS
		$I_{rr}=0.1 \times I_R$			
		$R_L=100\Omega$			
Capacitance	C	$V_R=0V, f=1MHz$	---	4	pF

Fig.1 Forward Characteristics

Fig.2 Reverse Characteristics

Fig.3 Capacitance Characteristics

Fig.4 Power Derating Curve


SOD-123 PACKAGE OUTLINE

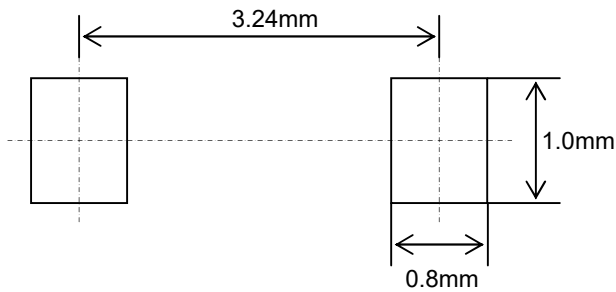
Plastic surface mounted package



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

Precautions: PCB Design

Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs


 Unspecified dimension tolerance: ± 0.5 mm

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